

Silicon Carbide (SiC) **Schottky Diode** - EliteSiC, 10 A, 1200 V, D3, TO-247-2L

NDSH10120C-F155

Description

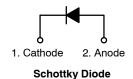
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- These Devices are Halogen Free/BFR Free and are RoHS Compliant

Applications

- · General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits





TO-247-2LD CASE 340DC

MARKING DIAGRAM



DSH10120C

= Specific Device Code

YWW

1

= Assembly Plant Code = Date Code (Year & Week)

ZΖ

= Lot Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

NDSH10120C-F155

ABSOLUTE MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Symbol | Parameter | | Value | Unit |
|-----------------------------------|---|--|-------------|------|
| V_{RRM} | Peak Repetitive Reverse Voltage | | 1200 | V |
| E _{AS} | Single Pulse Avalanche Energy (Note 1) | | 49 | mJ |
| l _F | Continuous Rectified Forward Current @ T _C < 145°C | | 10 | Α |
| | Continuous Rectified Forward Current @ T _C < 135°C | | | |
| I _{F, Max} | Non-Repetitive Peak Forward Surge Current | T _C = 25°C, 10 μs | 546 | Α |
| | | T _C = 150°C, 10 μs | 459 | А |
| I _{F,SM} | Non-Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 59 | А |
| I _{F,RM} | Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 31 | А |
| Ptot | Power Dissipation | T _C = 25°C | 94 | W |
| | | T _C = 150°C | 16 | W |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +175 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E_{AS} of 49 mJ is based on starting $T_J = 25^{\circ}C$, L = 0.5 mH, $I_{AS} = 14$ A, V = 50 V.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| $R_{	heta JC}$ | Thermal Resistance, Junction to Case, Max | 1.6 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max | 40 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|----------------|-------------------------|---|-----|------|------|------|
| V _F | Forward Voltage | I _F = 10 A, T _J = 25°C | - | 1.39 | 1.75 | V |
| | | I _F = 10 A, T _J = 125°C | - | 1.68 | - | |
| | | I _F = 10 A, T _J = 175°C | - | 1.94 | - | |
| I _R | Reverse Current | V _R = 1200 V, T _J = 25°C | - | 1 | 200 | μΑ |
| | | V _R = 1200 V, T _J = 125°C | - | 3 | 200 | |
| | | V _R = 1200 V, T _J = 175°C | - | 8 | 200 | |
| Q_{C} | Total Capacitive Charge | V = 800 V | - | 46 | - | nC |
| С | Total Capacitance | V _R = 1 V, f = 100 kHz | - | 680 | - | pF |
| | | V _R = 400 V, f = 100 kHz | - | 41 | - | |
| | | V _R = 800 V, f = 100 kHz | _ | 32 | - | |

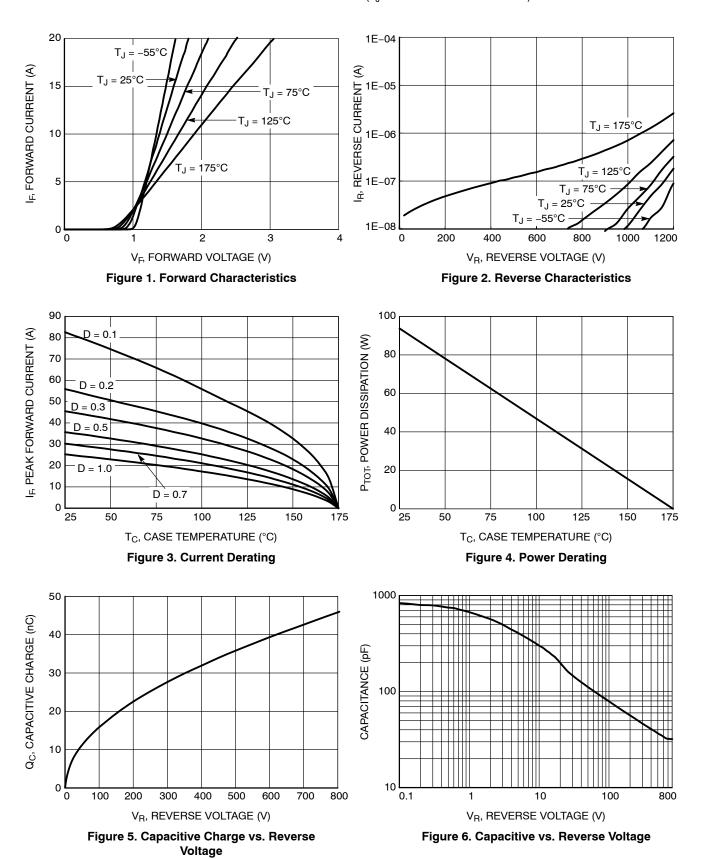
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Part Number | Top Marking | Package | Shipping |
|-----------------|-------------|--|-----------------|
| NDSH10120C-F155 | DSH10120C | TO-247-2LD (Pb-Free / Halogen Free) | 30 Units / Tube |

NDSH10120C-F155

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)



NDSH10120C-F155

TYPICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

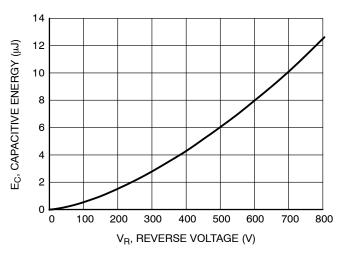


Figure 7. Capacitance Stored Energy

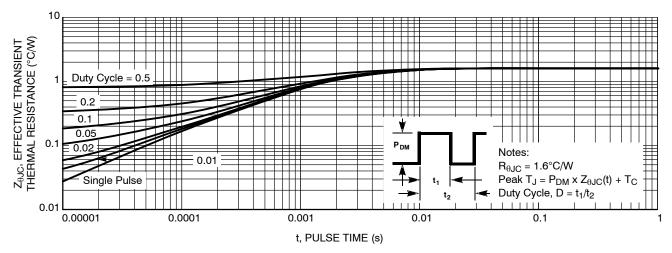
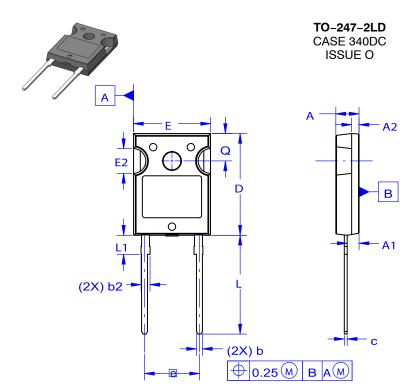
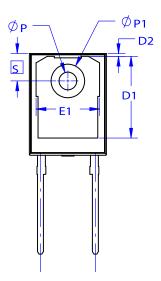


Figure 8. Junction-to-Case Transient Thermal Response Curve





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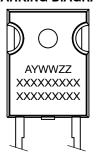


NOTES:

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

| DIM | MILLIMITERŞ | | | |
|--------------|-------------|-------|-------|--|
| DIM | MIN | NOM | MAX | |
| Α | 4.58 | 4.70 | 4.82 | |
| A 1 | 2.20 | 2.40 | 2.60 | |
| A2 | 1.40 | 1.50 | 1.60 | |
| b | 1.17 | 1.26 | 1.35 | |
| b2 | 1.60 | 1.72 | 1.84 | |
| С | 0.51 | 0.61 | 0.71 | |
| D | 20.32 | 20.57 | 20.82 | |
| D1 | 13.08 | ~ | ~ | |
| D2 | 0.51 | 0.93 | 1.35 | |
| Е | 15.37 | 15.62 | 15.87 | |
| E1 | 12.81 | ~ | ~ | |
| E2 | 4.96 | 5.08 | 5.20 | |
| е | ~ | 11.12 | ~ | |
| L | 19.75 | 20.00 | 20.25 | |
| L1 | 3.69 | 3.81 | 3.93 | |
| <u> </u> | 3.51 | 3.58 | 3.65 | |
| Ø P 1 | 6.60 | 6.80 | 7.00 | |
| Q | 5.34 | 5.46 | 5.58 | |
| S | 5.34 | 5.46 | 5.58 | |

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code A = Assembly Location

Y = Year

WW = Work Week
ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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|------------------|-------------|---|-------------|--|
| DESCRIPTION: | TO-247-2LD | | PAGE 1 OF 1 | |

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